

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
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RYOICHI SASAKI	04/01/2022
YASUSHI MORIHARA	04/01/2022
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17782061
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NAME OF SUBMITTER:	JANICE LOGAN
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DATE SIGNED:	06/03/2022
Total Attachments: 2	
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ASSIGNMENT

WHEREAS WE, the below named inventors, (hereinafter referred to as "Assignors"), have made an invention entitled:

MULTILAYER STRUCTURE AND METHOD FOR MANUFACTURING SAME,
PACKAGING MATERIAL AND PRODUCT INCLUDING SAME, AND PROTECTIVE SHEET FOR ELECTRONIC DEVICE

for which WE filed international application PCT/JP2020/045348 on December 4, 2020; and

WHEREAS **Kuraray Co., Ltd.**, whose post office address is 1621, Sakazu, Kurashiki-shi, Okayama 710-0801 Japan (hereinafter referred to as "Assignee"), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the applications of patent on this invention and the Letters Patent to be issued upon these applications;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee has hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and all United States applications, and all divisions, and continuations thereof, and all United States Letters Patents which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and divisionals and reissues thereof; and WE hereby authorize and request the Director of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, WE have hereunto set my hands.

Full Name of Assignor	Shuhei Kuzume
Address	c/o Kuraray Co., Ltd., 7471, Tamashimaotoshima, Kurashiki-shi, Okayama 713-8550 Japan
Signature	/Shuhei Kuzume/
Date	April, 1, 2022
Full Name of Assignor	Ryoichi Sasaki
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Signature	/Ryoichi Sasaki/
Date	April, 1, 2022

Full Name of Assignor	Yasushi Morihara
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Signature	/Yasushi Morihara/
Date	April, 1, 2022